September 2000

FDW2502P

SEMICONDUCTOR IM

Dual P-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

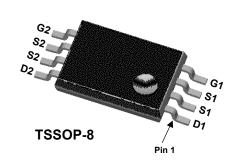
This P-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild's Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

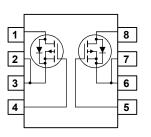
Applications

- Load switch
- Motor drive
- DC/DC conversion
- Power management

Features

- -4.4 A, -20 V. $R_{DS(ON)} = 0.035 \Omega @ V_{GS} = -4.5 V$ $R_{DS(ON)} = 0.057 \Omega @ V_{GS} = -2.5 V.$
- Extended V_{GSS} range (±12V) for battery applications.
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$.
- Low profile TSSOP-8 package.





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±12	V
I _D	Drain Current – Continuous	(Note 1a)	-4.4	А
	- Pulsed		-30	
PD	Power Dissipation for Single Operation	(Note 1a)	1.0	W
		(Note 1b)	0.6	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C
Therma	al Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	125	°C/W
		(Note 1b)	208	

_	Device Marking	Device	Reel Size	Tape width	Quantity
	2502P	FDW2502P	13"	12mm	3000 units

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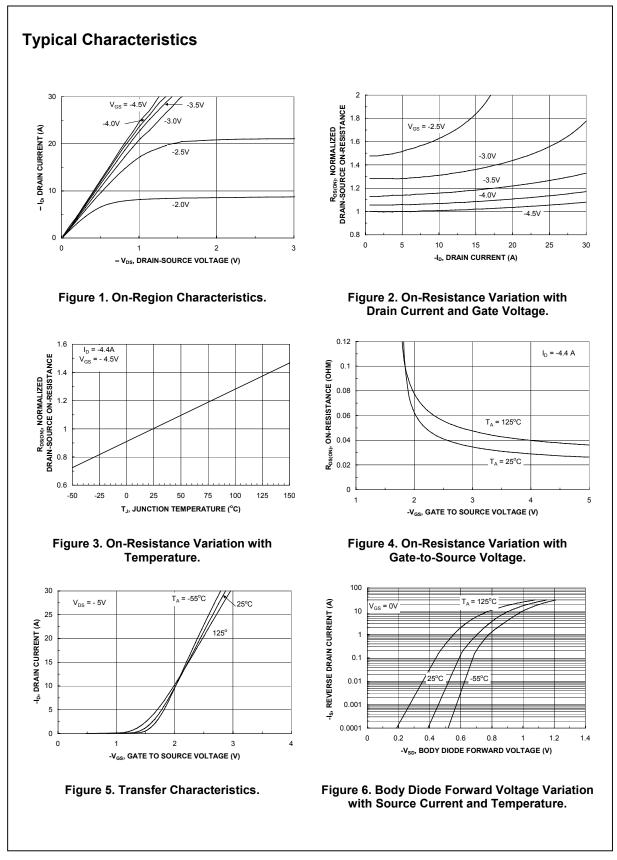
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-20			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = -250 µA, Referenced to 25°C		-17		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μA
IGSSF	Gate-Body Leakage, Forward	$V_{GS} = -12 V$, $V_{DS} = 0 V$			-100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	V _{GS} = 12 V, V _{DS} = 0 V			100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.6	-1.0	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		3.1		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = -4.5 V, I_D = -4.4 A$ $V_{GS} = -4.5 V, I_D = -4.4 , T_J = 125^{\circ}C$ $V_{GS} = -2.5 V, I_D = -3.3 A$		0.028 0.039 0.043	0.035 0.056 0.057	Ω
I _{D(on)}	On–State Drain Current	$V_{GS} = -2.5 V, I_D = -3.3 A$ $V_{GS} = -4.5 V, V_{DS} = -5 V$	-30			А
g fs	Forward Transconductance	$V_{DS} = -5 V$, $I_{D} = -4.4 A$		17		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			1330		pF
C _{oss}	Output Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$, f = 1.0 MHz		552		pF
C _{rss}	Reverse Transfer Capacitance	1 - 1.0 MHZ		153		pF
Switchin	g Characteristics (Note 2)		•	•	•	
t _{d(on)}	Turn–On Delay Time			12	25	ns
tr	Turn–On Rise Time	$V_{DD} = -10 V$, $I_D = -1 A$,		19	40	ns
t _{d(off)}	Turn–Off Delay Time	$V_{GS} = -4.5 V$, $R_{GEN} = 6 \Omega$		60	100	ns
t _f	Turn–Off Fall Time			37	70	ns
Qg	Total Gate Charge			14	20	nC
Q _{gs}	Gate-Source Charge	$V_{DS} = -5 V$, $I_D = -4.4 A$, $V_{GS} = -4.5 V$		3.0		nC
Q _{gd}	Gate-Drain Charge	- V _{GS} +.5 V		3.9		nC
Drain-Se	ource Diode Characteristics	and Maximum Ratings				
ls	Source Diode Characteristics and Maximum Ratings Maximum Continuous Drain–Source Diode Forward Current				-0.83	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -0.83 A$ (Note 2)		-0.7	-1.2	V

the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.

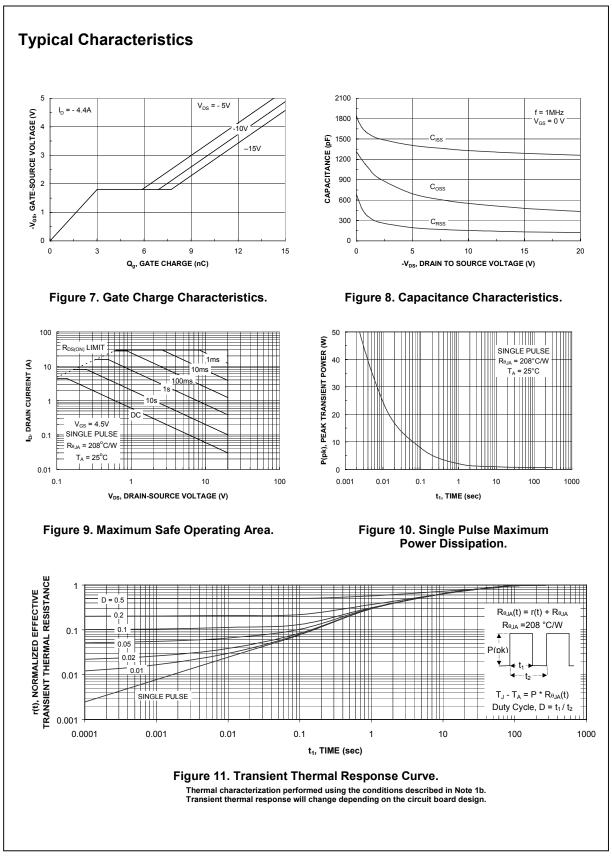
a) R_{θJA} is 125°C/W (steady state) when mounted on a 1 inch² copper pad on FR-4.
b) R_{θJA} is 208°C/W (steady state) when mounted on a minimum copper pad on FR-4.

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%



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FDW2502P Rev. D (W)



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